

FEATURES:

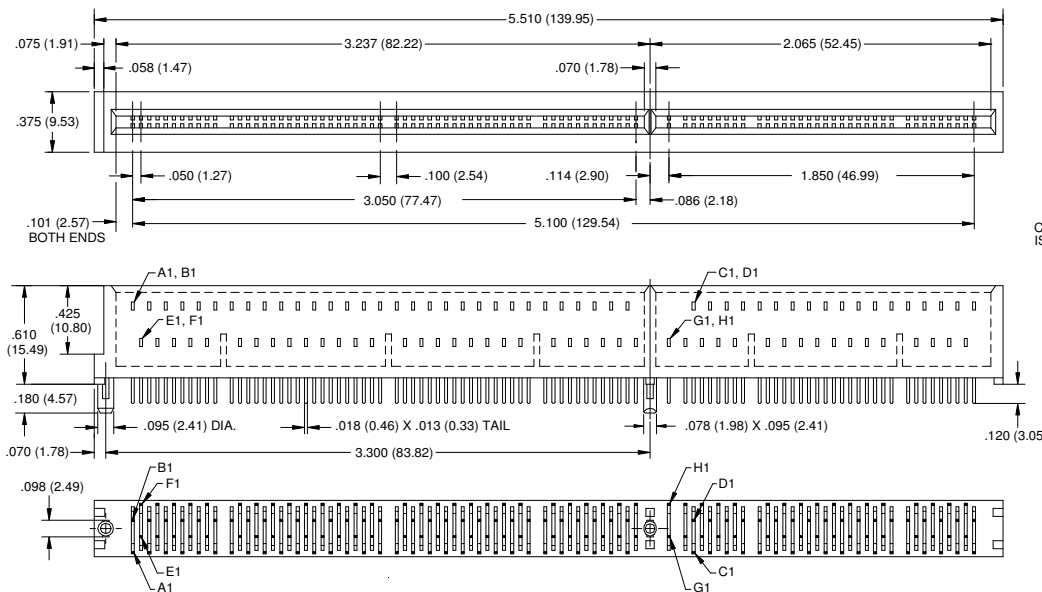
- EISA or ISA (IBM XT/AT) Daughter Boards Accommodated with Bi-Level Contact Points and Card Slot Depths.
- .050" (1.27mm) Contact Spacing with Staggered Tail Bend Results in 4 Rows at .100" (2.54mm) Spacing
- Accepts .062" (1.57mm) Nominal Thickness P.C. Board, Accurately Positioned by Card Slot Barrier
- High Profile Insulator Body, .610" (15.49mm)
- Mounting Posts Provide Positive Location and Retention
- P.C. Tail Contact Termination
- RoHS Compliant

Specifications:

Insulator Material	UL 94V-0 Polyphenylene Sulfide, Color: Black
Contact Material	Copper Alloy
Contact Plating	Gold Plating on mating area and Tin Plating on tails with Nickel underplating all over
Current Rating	1 Amperes
Contact Resistance	30 milliohms maximum
Dielectric Withstand Voltage	500 VAC rms at sea level between adjacent contacts
Insulation Resistance	1000 Megohms minimum
Operating Temperature	-55°C to +85°C
Insertion Force	6oz (1.67N) maximum per contact pair when tested with .062" (1.57mm) thick gauge
Withdrawal Force	.75oz (0.21N) minimum per contact pair when tested with .062" (1.57mm) thick gauge

Example Part Number: **301-188-520-201**

Series _____
 Total Number of Contacts _____
 Contact Code _____
 Style _____



SECTION THROUGH CONTACT POSITION SHOWING BOTH UPPER AND LOWER TIER CONTACTS (OPPOSING CONTACTS ARE ACTUALLY ON THE SAME TIER)

